TECH PUBLIC
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SUD50N06-09L-TP

N-Channel Enhancement Mode MOSFET

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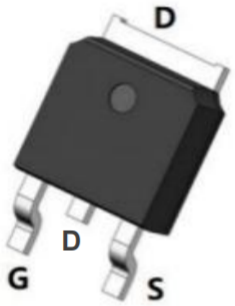
Product Summary

- V_{DS} 60 V
- I_{DS} 80A
- $R_{DS\ (ON)}$ (at V_{GS}=10) ≤ 6.6mΩ (Typ)
- Low Gate Charge Minimize Switching Loss

Application

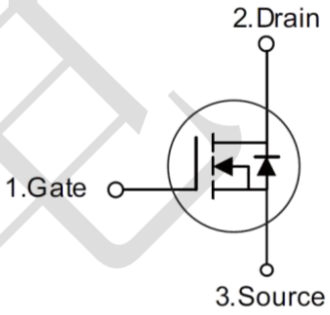
- Adaptor
- Charger
- Power management
- SMPS Standby Power

Package and Pin Configuration



T0-252

Circuit diagram



Absolute Maximum Ratings

(T_A=25℃unless otherwise noted)

PARAMETER	SYMBOL	Value	UNIT
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	80	A
Continuous Drain Current (TC=100℃)	I_D	56	A
Pulsed Drain Current (Note 1)	I_{DM}	240	A
Maximum Power Dissipation @T_A=25℃	P_D	68	W
Single Pulsed Avalanche Energy(2)	E_{AS}	225	mJ
Operating Junction Temperature Range	T_J	+150	℃
Storage Temperature Range	T_{stg}	-55 to +150	℃

Note : 1.When mounted on 1" square PCB (FR4 material).

2. E_{AS} condition: Tj=25℃,V_{DD}=30V,V_G=10V,L=0.5mH,R_g=25Ω

Electrical Characteristics (T_A=25℃unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250μA	BV_{DSS}	60	--	--	V
Gate-Source Threshold Voltage	V_{DS}=V_{GS} , I_D=250μA	$V_{GS(th)}$	1.2	1.7	2.2	V
Gate-Source Leakage	V_{DS}=0V, V_{GS}= ±20V	I_{GSS}	--	--	±100	nA
Zero Gate Voltage Drain Current	V_{DS}= 60V, V_{GS}=0V	I_{DSS}	--	--	1	μA
Drain-Source On-State Resistance	V_{GS}= 10V, I_D= 30A	R_{DS}(on)	--	6.6	8.0	mΩ
	V_{GS}= 4.5V, I_D= 30A		--	9.3	11	
Forward Trans conductance	V_{DS}=5V,I_D=30A	g_{FS}	--	30	--	S
Dynamic (Note 2)						
Total Gate Charge (Note 3)	V_{DS}= 30V, I_D =20A, V_{GS}= 10V	Q_g	--	31	--	nC
Gate-Source Charge (Note 3)		Q_{gs}	--	6.0	--	
Gate-Drain Charge (Note 3)		Q_{gd}	--	5.0	--	
Input Capacitance	V_{DS} = 30V, V_{GS} = 0V, F= 1.0MHz	C_{iss}	--	1990	--	pF
Output Capacitance		C_{oss}	--	470	--	
Reverse Transfer Capacitance		C_{rss}	--	14	--	
Switching						
Turn-On Delay Time (Note 3)	V_{DD} = 30V, I_D= 2A, V_{GS} = 10V, R_G = 3Ω	$t_{d(on)}$	--	16	--	nS
Rise Time (Note 3)		t_r	--	8.0	--	
Turn-Off Delay Time (Note 3)		$t_{d(off)}$	--	45	--	
Fall Time (Note 3)		t_f	--	33	--	
Source-Drain Diode Ratings and Characteristics (Note 2)						
Forward Voltage	V_{GS} = 0V, I_S = 10A	V_{SD}	--	0.8	1.2	V
Continuous Source Current	Integral reverse diode in the MOSFET	I_S	--	--	80	A
Pulsed Current (Note 1)		I_{SM}	--	--	240	A

Notes:

1. Pulse test; pulse width ≤ 300 μS, duty cycle ≤ 1%.
2. Guaranteed by design, not subject to production testing.
3. Independent of operating temperature

TYPICAL CHARACTERISTICS (T_A=25℃unless otherwise noted)

Fig. 1-Output Characteristics

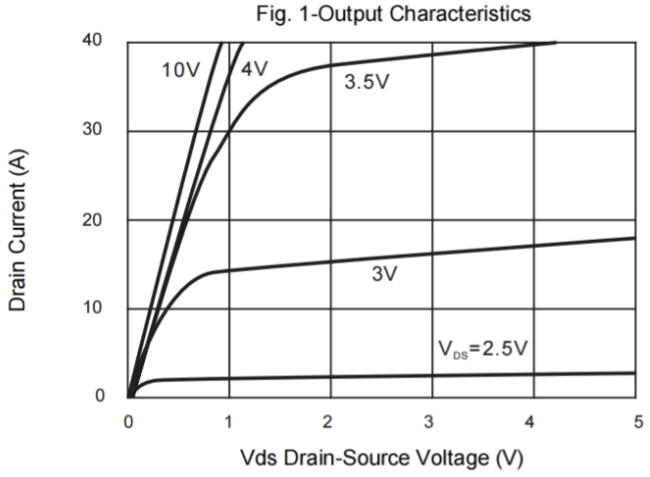


Fig. 2-Rdson-JunctionTemperature

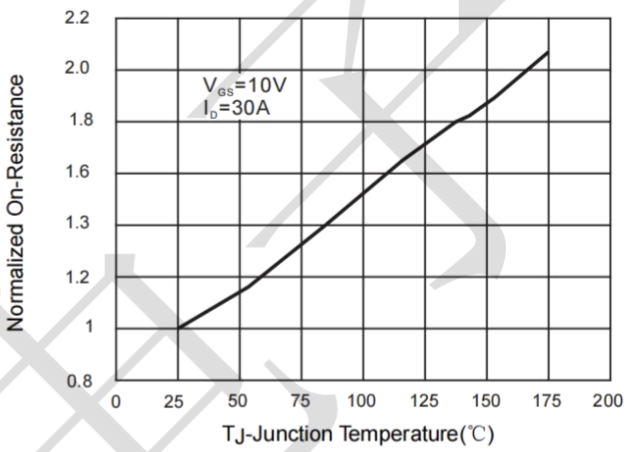


Fig. 3-Transfer Characteristics

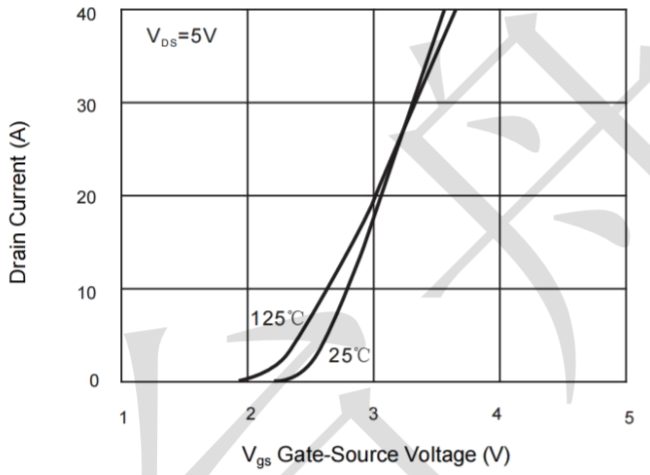


Fig. 4 - Total Gate Charge Characteristics

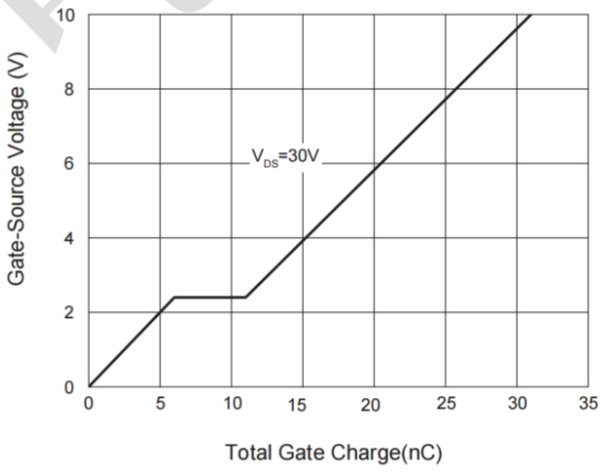


Fig. 5-Rdson- Drain Current

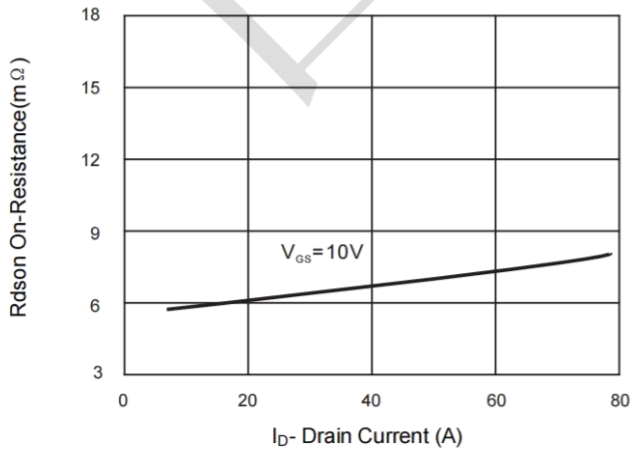
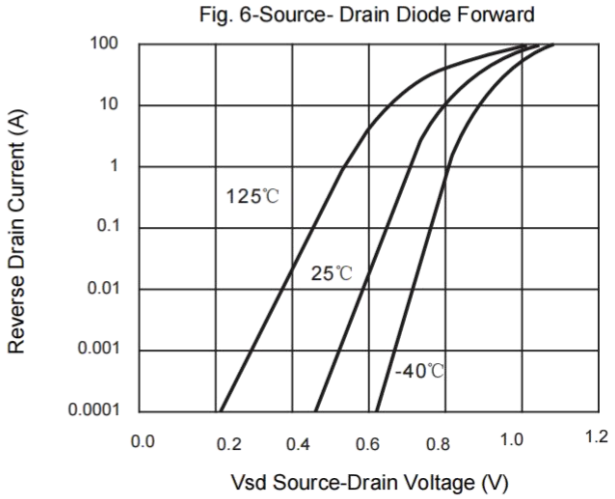


Fig. 6-Source- Drain Diode Forward



Package Outline Dimensions (unit: mm)

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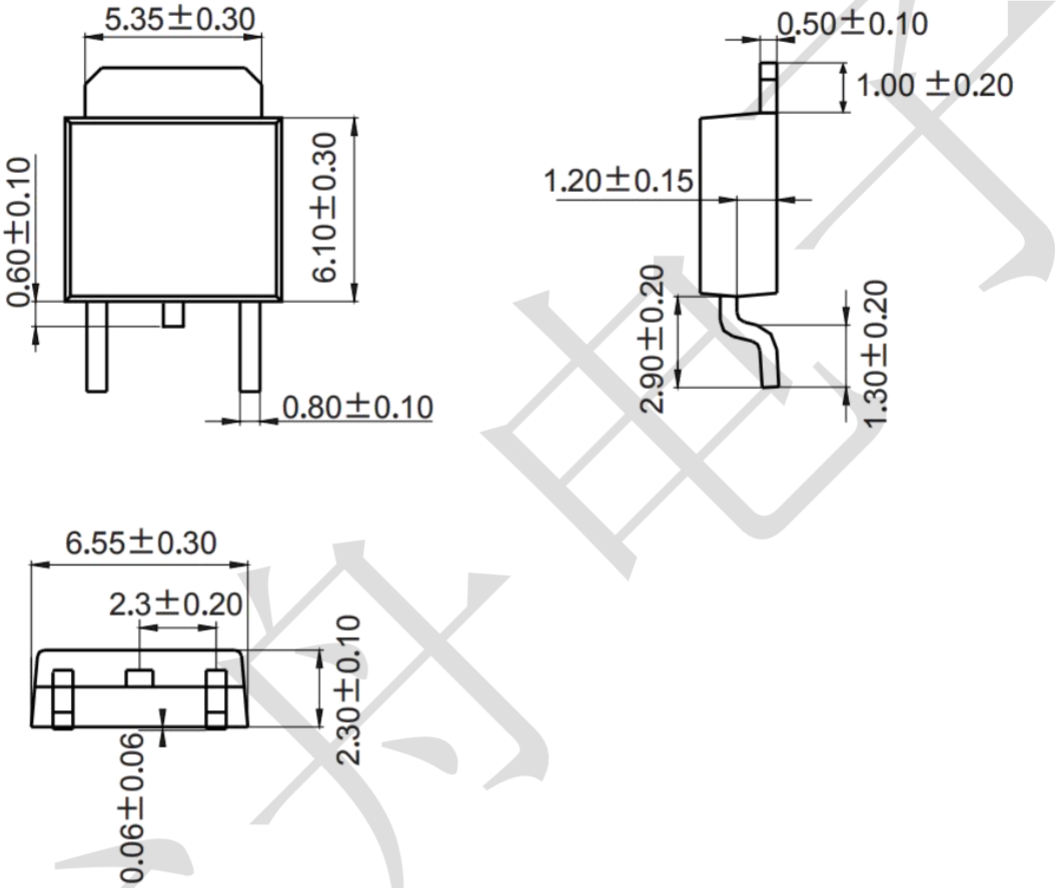

Mounting Pad Layout (unit: mm)